T.I.C. Activities

The Sixteenth General Assembly of the Tantalum Producers International Study Center will be held in Brussels on Thursday, October 29th 1981, to carry out the formal business of the association. The agenda will include the election of the Executive Committee and Officers for the coming year.

Following the Assembly, there will be a complementary programme of presentations and discussions on subjects of interest to members and their guests.

SEVENTEENTH GENERAL ASSEMBLY

The Seventeenth General Assembly will be held in early June 1982 at Tulsa, Oklahoma, U.S.A. Fansteel, Inc. will be the host company and expects to include a visit by delegates and guests to their basic-processing plant in nearby Muscogee, Oklahoma. The exact dates and programme will be established during the Sixteenth General Assembly. Members should be planning their schedules for attendance of this interesting meeting.

PUBLICATIONS OF THE T.I.C.

There are still a number of copies of the “Proceedings of the First International Symposium on Tantalum” available. They may be ordered at US $ 25 each from the Secretary, rue aux Laines 1, 1000 Brussels, Belgium.


Japanese tantalum consumption

Due to the lack of published data, the T.I.C. “Bulletin” has not included tantalum data from Japan since issue no. 19 in September 1979. During a recent visit to Japan, the Editor collected enough information from various sources for the following article.

Consumption of tantalum products in Japan during 1979 and 1980 have been compared on the same basis as previously published data for 1977 and 1978:

<table>
<thead>
<tr>
<th>Product (unit : m.t.)</th>
<th>1977</th>
<th>1978</th>
<th>1979</th>
<th>1980</th>
</tr>
</thead>
<tbody>
<tr>
<td>Powder (Cap. &amp; Metall. Gr.)</td>
<td>76.3</td>
<td>73.5</td>
<td>105.0</td>
<td>92.8</td>
</tr>
<tr>
<td>Chemical Compounds (Carbide &amp; Oxide)</td>
<td>38.0</td>
<td>44.0</td>
<td>52.0</td>
<td>42.4</td>
</tr>
<tr>
<td>Mill Products (Elecir. &amp; Chemical)</td>
<td>25.2</td>
<td>28.4</td>
<td>37.4</td>
<td>36.9</td>
</tr>
<tr>
<td>Total</td>
<td>139.5</td>
<td>145.9</td>
<td>194.4</td>
<td>172.1</td>
</tr>
<tr>
<td>% Growth Rate</td>
<td>+1 %</td>
<td>+4.6 %</td>
<td>+33.2 %</td>
<td>-11.5 %</td>
</tr>
</tbody>
</table>

An approximate division among market segments shows the predominance of use by the electronics industry:

<table>
<thead>
<tr>
<th>Market Segment</th>
<th>1978</th>
<th>1979</th>
<th>1980</th>
</tr>
</thead>
<tbody>
<tr>
<td>Electronics</td>
<td>61</td>
<td>67</td>
<td>68</td>
</tr>
<tr>
<td>Industrial</td>
<td>9</td>
<td>6</td>
<td>8</td>
</tr>
<tr>
<td>Cutting Tools</td>
<td>20</td>
<td>19</td>
<td>17</td>
</tr>
<tr>
<td>Lens</td>
<td>10</td>
<td>8</td>
<td>7</td>
</tr>
<tr>
<td>Total</td>
<td>100</td>
<td>100</td>
<td>100</td>
</tr>
</tbody>
</table>

T.I.C. SIXTEENTH GENERAL ASSEMBLY

The Sixteenth General Assembly of the Tantalum Producers International Study Center will be convened at 9.30 a.m. on Thursday, October 29th 1981 at the Cercle Royal Gaulois, rue de la Loi 5, 1000 Brussels.

The agenda for the meeting will be:
1. Presidential greetings and address to the members.
2. Minutes of the Fifteenth General Assembly.
3. New member election.
7. Seventeenth General Assembly.
8. Other business.

After the formal meeting, there will be a presentation on a subject of general interest to the delegates. The name of the speaker and the topic for discussion will be announced shortly.

The General Assembly is open to delegates of member companies and their associates. Prospective new members and invited guests of member companies may join the meeting for the programme following the formal business of the association.

For further details of the meeting arrangements or information on the T.I.C., please contact Mrs J.A. Wickens, Secretary, Tantalum Producers International Study Center, rue aux Laines 1, 1000 Brussels, Belgium; cable address Tictan Brussels.
The proportion of the total consumption by the electronics industry has been steadily increasing during the past ten years from 54 % in the early part of the decade to the 68 % currently. This has continued regularly but in a lesser proportion than the growth in the number of capacitor units produced each year. Examination of trends shows that the consumption of powder per unit of capacitors produced is now only one-quarter of what it was in 1973.

The decline in market share for uses other than electronics is only the result of the electronics market growing at a greater rate. Consumption in these areas has been reasonably stable. The consumption of carbide and oxide reached a peak in 1979 but much of that material was used to replace inventories in view of a threatened shortage. With signs of economic slump developing by mid-1980, the consumers of carbide and oxide began to reduce inventories and a drop-off in sales of new product resulted. There are no serious indications of either accelerated scrap recycle or extensive substitution in the carbide market.

The source of the materials consumed, imports versus domestic production, indicates a continuous stable market for export to Japan in about the same proportion of the market as always.

<table>
<thead>
<tr>
<th>Source (unit: m.t.)</th>
<th>1978</th>
<th>1979</th>
<th>1980</th>
</tr>
</thead>
<tbody>
<tr>
<td>Imports</td>
<td>50.2</td>
<td>72.7</td>
<td>57.7</td>
</tr>
<tr>
<td>Domestic production</td>
<td>95.7</td>
<td>121.7</td>
<td>114.4</td>
</tr>
<tr>
<td>Total</td>
<td>145.9</td>
<td>194.4</td>
<td>172.1</td>
</tr>
<tr>
<td>% Produced in Japan</td>
<td>65.6</td>
<td>62.6</td>
<td>66.5</td>
</tr>
</tbody>
</table>

The proportion of consumption which is domestically produced has been relatively constant, ranging from 61.5 % in 1974 to a high of 68.4 % in 1976.

The metal producers continue to rely on sources in Europe and United States for their supply of potassium fluotantalate as there is no production of the salt in Japan. But the domestic production, from imported ores and slags, of tantalum carbide and oxide continues to be about 72-73 % of the total consumption of these materials.

A rough forecast indicates that the tantalum industry expects a drop in total consumption in 1981 of about 15 %, 25 m.t. on a metal basis. Almost all of this drop will be in the electronics industry, partly as a result of the general world economic condition and partly due to the continuing trend of using less material per unit produced by the capacitor makers.

T.I.C. Plant Tour at Hermann C. Starck Berlin

As a part of the programme of the Fifteenth General Assembly of the T.I.C. in May 1981, delegates and guests were treated to a detailed plant tour of the integrated tantalum facility which constitutes a large part of the Goslar, West Germany, plant of Hermann C. Starck Berlin.

The extractive metallurgy of tantalum

The following article has been taken from a presentation written by Peter Borchers and George J. Karinek of Hermann C. Starck and used as an introduction to the tour of the Goslar, West Germany.
plant of Starck during the programme of the Fifteenth General Assembly of the T.I.C. in May 1981.

Separating from the accompanying elements and purification are the main targets of the extractive metallurgy of tantalum. In order to optimize the unique properties of tantalum, the metal or the compound must have a high degree of purity. Direct application in the form of a ferro-alloy, which is common in other refractory metals, e.g. the sister metal niobium, is not possible. The type and number of operations needed depend on the grade and nature of the raw materials.

Tantalum occurs generally in close association with niobium, titanium and tin, sometimes with rare earths, uranium and thorium. Most of the placer or pegmatite type of ore can be enriched by wet gravity, magnetic or electrostatic methods or flotation to concentrates containing up to 70% combined Ta₂O₅ and Nb₂O₅. Compositions of the main types of concentrates, the traditional raw materials of the processing industry, are:

| Tantalite  | 40-80% Ta₂O₅ | 2-30% Nb₂O₅ |
| Columbite  | 1-40% Ta₂O₅  | 40-57% Nb₂O₅ |
| Wodginite  | 45-56% Ta₂O₅ | 3-15% Nb₂O₅ |
| Microlite  | 50-70% Ta₂O₅ | 5-10% Nb₂O₅ |

Only a small portion of the tantalites closely associated with the tin mineral cassiterite can be recovered by beneficiation methods. The bulk of the tantalum is collected in tin slags from the tin smelters in different grades depending on the original concentration in the tin concentrates and the efficiency of the smelting operation.

<table>
<thead>
<tr>
<th>Source</th>
<th>% Ta₂O₅</th>
<th>% Nb₂O₅</th>
<th>% TiO₂</th>
<th>% FeO</th>
</tr>
</thead>
<tbody>
<tr>
<td>High Grade</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Australia</td>
<td>10</td>
<td>5.5</td>
<td>9</td>
<td>10</td>
</tr>
<tr>
<td>Zaire</td>
<td>11</td>
<td>9</td>
<td>13</td>
<td>10</td>
</tr>
<tr>
<td>Medium Grade</td>
<td>5</td>
<td>7</td>
<td>2</td>
<td>14</td>
</tr>
<tr>
<td>South Africa</td>
<td>4</td>
<td>12</td>
<td>7</td>
<td>13</td>
</tr>
<tr>
<td>Nigeria</td>
<td>4</td>
<td>12</td>
<td>7</td>
<td>13</td>
</tr>
<tr>
<td>Malaysia</td>
<td>4</td>
<td>4</td>
<td>11</td>
<td>15</td>
</tr>
<tr>
<td>Thailand</td>
<td>5</td>
<td>4</td>
<td>18</td>
<td>11</td>
</tr>
<tr>
<td>Low Grade</td>
<td>0.8-2</td>
<td>0.8-2</td>
<td>5-9</td>
<td>18</td>
</tr>
<tr>
<td>Malaysia</td>
<td>0.3-1</td>
<td>0.2-1</td>
<td>1-5</td>
<td>20</td>
</tr>
<tr>
<td>Thailand</td>
<td>0.2-1</td>
<td>0.2-1</td>
<td>1-5</td>
<td>20</td>
</tr>
<tr>
<td>Brazil</td>
<td>1-2</td>
<td>2-4</td>
<td>20</td>
<td>8</td>
</tr>
<tr>
<td>Singapore</td>
<td>1-2</td>
<td>1-2</td>
<td>15</td>
<td>19</td>
</tr>
</tbody>
</table>

Slags with Ta₂O₅ content of more than 10% have been or are treated directly by chemical means to recover Ta/Nb. Whereas the development of new sources of tantalite looks promising at present, it is unlikely that the availability of high-grade slags will increase substantially in the near future. Therefore, the utilization of low-grade tin slags is an absolute necessity to close the gap between supply and demand. The tonnage-wise more abundant slags below 2% Ta₂O₅ were long considered worthless and were used for road construction and sand-blasting. But now, after an explosion of the tantalum raw material price, they are mined for sale.

Since slag is an artificial, homogeneous and glass-like product, ore treatment methods fail to upgrade. Selective chemical methods like acid- and alkali-leaching or chlorination also fail or are only partially successful. Nor are the results better in an attempt to recrystallize the slag in a plasma arc to get new boundaries amenable to selective chemical treatment.

Electric melting processes are successful: melting the slag in an electric arc furnace, sometimes with the addition of an iron source, and reducing with carbon, collecting the Ta/Nb carbides in the form of a ferro-alloy.

For further enrichment of the alloy, three main production routes are used:
1) Leaching the iron with mineral acids, sometimes followed by an alkali leach, and converting the carbides to acid-soluble oxide by an oxidizing roast.
2) Chlorinating the alloy in a sodium-iron-chloride melt, yielding a raw chloride mixture which is subsequently hydrolyzed or separated by fractional distillation.
3) Remelting with addition of oxidizing agents.

The application of this method is limited, less so for technical than for economic reasons, considering the extensive HF consumption for non-oxide constituents like SiO₂, TiO₂ and Fe₂O₃. The separation of the highly corrosive Ta/Nb/Ti solution from insoluble material is a special problem which is partly overcome by decantation processes or solved by filtration in closed automatic filter devices. The insoluble residues which still contain valuable Ta/Nb contents can be recycled or melted in the tin slag process.

Modern solvent extraction techniques have totally replaced the previous Marignac process in which Ta and Nb were separated by multi-stage fractional crystallization of the potassium double salts. In the early fifties, the US Bureau of Mines systematically tested a great number of acid and solvent systems which made it possible to extract tantalum, preferentially to niobium and other elements, into an organic solvent.

The HF/H₂SO₄ system, which allows high extraction recoveries in the digestion step, is well suited for subsequent liquid-liquid extraction. In a typical modern industrial-sized unit, first Ta and Nb
are co-extracted in the methyl-isobutyl ketone, from highly acid HF/H₂SO₄ solutions and separated from Ti and most of the other constituents of the aqueous solution. Then niobium is stripped with dilute acid, and finally tantalum is extracted by ammonium fluoride.

This ideal combination of separation and purification by solvent extraction, which is preferably performed in simple multi-stage mixer and settler units, can be considered as one of the most important developments in the history of tantalum and columbium chemistry.

Tantalum and niobium hydroxides are precipitated with ammonia from the corresponding strip solutions and converted to the oxides by calcining. Potassium tantalum fluoride, the "K-Salt", is crystallized by adding potassium ions to the organic tantalum phase or the tantalum strip solution. Because of the good crystallization characteristics and low solubility of this tantalum compound, it is possible to achieve additional purification. The recycled ketone must be regularly cleaned by distillation.

THE CHLORIDE PROCESS

Most of the constituents of tantalum ore form stable anhydrous chlorides, their boiling points differing over a wide range. So the chlorination technology offers good possibilities for extraction and purification. The use of low cost chemicals is another advantage, while working in a closed system favours good environmental conditions.

In the sixties, the Swiss company CIBA developed this chemistry successfully into an industrial technique to produce pure Ta and Nb compounds in tonnage size. The decomposition and extraction step was first done in the traditional manner, introducing dry chlorine in a heated mixture of ore and reducing agent. But this technique was replaced soon by a less difficult and more economic process in which a Ta/Nb ferro-alloy was chlorinated in a melt of sodium-iron chloride. The volatilized chlorides were roughly separated in a solid fraction containing Ta, Nb and other high-boiling point chlorides, and a liquid fraction containing the low-boiling chlorides of Ti, Si and Sn. Iron chlorides were retained in the salt melt which is a great improvement over the oxide chlorination.

The solid chloride mixture is separated by fractional distillation in heated packed glass columns using the very small difference in boiling points of the TaCl₅ (232 °C) and NbCl₅ (245 °C). The pure chlorides are converted to oxides by means of a special steam hydrolysis or taken as feed material for the metal reduction.

Because only glass, quartz or teflon material is in contact with the chlorides and no additional chemicals are used, it is possible to produce extremely pure compounds. Since sophisticated equipment and maintenance are expensive, production costs are remarkably high and the use of this technology is only justified where a higher degree of purity is required, e.g. in optical glasses where the content of colouring systems must be far below 5 ppm. Other important applications of the chlorides are in C.V.D. or as feed material for plasma and submicron powders.

TANTALUM CARBIDE AND METAL POWDERS

Tantalum oxide is the feed material for the production of tantalum carbide which is produced by heating an intimate mixture of the oxide with lamp-black in an oxygen-free system at 1600 °C-1800 °C. The adjustment of the combined and free carbon is normally performed in induction-heated vacuum furnaces by the addition of either oxide or carbon. Solid solutions of TaC and NbC or TaC, TiC and WC, which are increasingly required by the cemented carbide industry, need high temperature vacuum treatment, i.e. 2000 °C, to achieve the 99.9% formation of mixed crystals.

Generally very fine and porous powders are obtained from carbon-and sodium-reduction, more dense and dendritic powder from the fused-salt electrolysis. The simpler and less expensive fluoride method favours the use of K-salt as a feed material for metal reduction. Geographically, the fused salt electrolysis was first, and in comparatively large size, introduced in the USA (Fansteel), while the sodium reduction was first used in Europe - Germany and U.K.

The final decision for most processing companies to employ primarily only sodium reduction was stimulated by the required powder quality for the growing demand of the electronics industry. This industry processes generally two types of capacitor grade powders:

1) The sodium-reduced high capacitance powder for lower working voltage applications (consumer and automotive industry)
2) the "melted" (or EB melted) powder with medium capacitance for high working voltages (military and aerospace industries).

It is evident that the melted powders can be produced from any kind of pure tantalum metal by EB or arc melting and subsequent embrittlement with hydrogen, comminuting, degassing, etc.

On the basis of present knowledge, however, the growing demand for high-capacitor powders - more capacity per weight of tantalum and per volume of capacitor - can only be met by improving the sodium reduction process.
consisting of oxidation and comminution, tungsten extraction, and cobalt extraction and the final recovery of a Ta/Nb/Ti oxide mixture with smaller amounts of the other constituents. These sludges are used as feed for solvent extraction plants. The overall recovery rate of this tantalum is estimated to be still fairly low.

Tantalum capacitors in Japan

The following paper was presented at the Fifteenth General Assembly of the T.I.C. by Mr. Hidehito Okada, Vice President, Nippon Electric Company Limited.

The reputation of N.E.C. in expanding the Japanese tantalum capacitor market should be shared with tantalum material suppliers who have always tried to give us their best cooperation in improving tantalum powder quality and to achieve a positive outcome. As it goes, I extend my respect and appreciation to all of those material suppliers.

Skyrocketing prices of tantalum materials during the past three years, however, caused critical damage to all of the tantalum capacitor manufacturers. The price hikes were far from being too frequent for capacitor manufacturers to absorb them by own cost reduction efforts. We were forced to pass those increased costs on to our customers and, as a result, lost a considerable part of the tantalum capacitor market created and maintained by our continuous efforts in the past.

Until 1978, price increase of tantalum materials had taken place rather gently so that the capacitor manufacturers could absorb increased costs and could expand the market. Development of higher CV value powders by tantalum material suppliers and improvement of process technology by capacitor manufacturers went hand in hand gradually to decrease consumption of tantalum powder per capacitance value ever since 1979. Miniaturization in tantalum capacitor sizes, made possible by the improvement in CV value per gram, also contributed to the healthy growth of the tantalum capacitor market.

HISTORY OF TANTALUM CAPACITORS IN JAPAN

The first transistor application to electronic products started with radios in 1955 and it was just a matter of course to apply them to telecommunication equipment too. Since the first application to capacitors, this ten-cent-of that in electron tube circuits, electrolytic capacitors are most suitable in view of their features, large capacitance in small physical size. Their low rated voltage characteristics are not disadvantageous to use in transistor circuits do not require high voltage operation as electron tube circuits do.

Aluminum electrolytic capacitors available at that time were not sufficient in impedance characteristics and were considered rather unreliable because of the dry-up problem. They were reasonably good for consumer electronics like radios but were not good enough for telecommunication equipment which required rather high reliability over a long period of time.

In 1956, for the first time in Japan, tantalum capacitors were put into practical application in transistorized carrier transmission equipment. They were wet tantalum foil capacitors, not solid type capacitors which were still in the development stage. Tantalum foil capacitors, however, using liquid electrolyte, like aluminum electrolytic capacitors, still had insufficient reliability since they also had a possibility of the dry-up problem. In order to solve this, NEC developed solid electrolytic tantalum foil capacitors, different from currently used solid tantalum capacitor in that germanium was used as the solid electrolyte and aluminum was used as the cathode electrode. Windings with a core made of polyester, however, made it very difficult to produce in quantity as the tantalum oxide film formed on the foil surface was too sensitive to accept mechanical stress. Therefore, they did not find wide application.

About three years later, in 1959, sintered slug type solid tantalum capacitors, originally developed by Bell Laboratories in the U.S., were adopted for telecommunication equipment in Japan. Since then, the main stream of tantalum capacitors has been the solid type. They have even been adopted by NEC in the military equipment in the industrial market for telecommunications and computers.

Technological progress in the late 60's in improving humidity characteristics made it possible to produce solid tantalum capacitors encapsulated in epoxy resin. This provided enormous possibilities to the tantalum capacitor industry to penetrate the broad range of the consumer electronics market. Resin-dipped tantalum capacitors have reached about 85% of the total tantalum capacitors sold in Japan. Through cost reduction efforts and the performance characteristics and small physical size, resin-dipped tantalum capacitors have attained superiority over aluminum electrolytic capacitors and have attained the remarkable market penetration.
TANTALUM CAPACITORS IN JAPAN

Demand for tantalum capacitors in Japan is overwhelming in consumer electronics where resin-dipped are dominant. The Japanese market differs to a great extent from that in the U.S. or Europe. In the U.S., the demand for resin-dipped devices is increasing but they are still estimated to be below 50% of the market. This difference in market situation can be explained by the fact that the Japanese electronics industry is still dominated by consumer electronics, although telecommunication, computer and other industrial applications have reached 45% of the total. In the U.S., industrial electronics, together with military electronics, are estimated to be 88% of the total.

Resin-dipped tantalum capacitors are used as follows in the Japanese market:

- Television ........................................... 7.5%
- Video tape recorders ............................... 12.8%
- Stereo systems ..................................... 3.1%
- Stereo tape decks ................................. 1.6%
- Radio Cassette recorders ....................... 4.8%
- Tape recorders .................................... 18.0%
- Car stereo .......................................... 18.6%
- Toys .................................................. 10.7%
- Elec. Music instr. .................................. 2.3%
- Camaras ............................................ 14.3%
- Elec. Mechanical Equip. ....................... 0.8%
- Electronic calculators ............................ 5.6%

The reasons why tantalum capacitors are so widely used in these areas are the need for small physical size, the excellent performance characteristics compared to other types and the superiority of tantalums in price, physical size and electrical performance in synthetic consideration. Since 1979, however, the latter category has completely faded out due to the price hikes, the emergence of subminiature aluminum electrolytic capacitors (30% physical size reduction) and aggressive pricing of monolithic ceramic capacitors resulting from cost reductions. Jnner ceramic films for higher capacitance sizes and smaller physical size.

Besides price hikes, the uncertain prospects for tantalum materials gave customers both anxiety and distrust against tantalum capacitors. Since tantalum capacitor manufacturers could not have any clear picture for the future, there was no way for us to give a definite answer to our customers about future prices and material shortages. The situation was so desperate that we were forced just to let our market go to other capacitors while we asked only minimum price increases from our customers. The bad influence of tantalum capacitor price hikes in those major applications where resin-dipped tantalums are used is shown by comparison:

TANTALUM CAPACITORS IN THE FUTURE

Electronics is one of the most promising industries for the next generation. But the more the electronics industry develops, the severer the market competition will be. Only the people who can meet the competition will be able to enjoy prosperous dollar volume business like the enormous increase in production quantities.

Since I have been with the tantalum capacitor business for almost 30 years, it is my earnest desire that we can minimize the bad influence of material price hikes to the capacitor market and lend our experience to future business expansion. From this standpoint, let's look at the future tantalum market in Japan.

1) Industrial markets (Telecommunications, computers, etc.)
   Stable, but not rapid, growth is projected because high reliability is the first priority.

2) Consumer markets (75% of the total and very competitive)
   Moderate growth based on product development focused on miniaturization of current devices and greater use of chip style devices.

3) Automotive market
   Rapid expansion.

Since the Japanese tantalum capacitor industry relies heavily on the consumer market, the detail about what we should do in the future is:

1) Miniaturization — The electronics industry has an insatiable demand for miniaturization. In a portable stereo, now booming throughout the world, tantalum capacitors, due to price increase, were replaced by other types to reduce cost. But, because of miniaturization, the most advanced models have come back to tantalums as only the small physical size can meet the miniaturized design. Portable consumer electronic products will have stepped growth in the future and the pursuit of smaller tantalum capacitors will maintain the market.

2) Automatic Assembly — Along with miniaturization, automation for the assembly of consumer electronics is rapidly advancing. The new technology requires as many as possible of the chip-style components for direct surface mounting on printed circuits. Chip components save space, enhance the speed, and reduce the weight of the circuit board by a half. In some cases, it can be mounted onto the soldering side of the P.C. boards to minimize the P.C. board size.

3) Automotive electronics — High reliability is the greatest concern especially in systems which are directly related to human life such as emission control, anti-skid devices, etc. For these critical applications, tantalum capacitors are advantageous in their superior temperature range, high reliability, and small physical size.

I believe that the advantages of tantalum capacitors in electrical performance and small physical size over all other capacitors still provides a possibility of more effective utilization than aluminum electrolytic capacitors and monolithic ceramics. This outlook is based on our estimation that the CV value of tantalum powder will go up to around 30,000 within four to five years. Since greater progress is projected in monolithic ceramic capacitors, however, I feel that they will be more competitive than aluminum electrolytics.

CONCLUSION

In the Japanese market, dominated by consumer electronics, miniaturization of tantalum capacitors and tantalum chip capacitors, suitable for automatic assembly, are eagerly required. Development of higher CV rated powders is urgently needed to meet the market requirements. This is not only a must to recover the lost market, but also it is the only way to bring long term and healthy growth in the tantalum capacitor business. And it will also save precious tantalum mineral resources.

Now is the time, I have to emphasize, for closer mutual cooperation among tantalum miners, tantalum material producers and tantalum capacitor manufacturers than ever before. It is our responsibility to fulfill our customers' needs with well balanced services attainable only through combined efforts by reasonable ore prices, development of higher CV powders, and improvement of capacitor design and manufacturing. I am sure that mutual cooperation promises a fruitful and beneficial business in many industries in the future.

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